

NRZ

(0.80 mm) .0315" PITCH • QTE/QSE SERIES

QTE **Board Mates:** OSF

QSE Board Mates: OTF

QTE/QSE Cable Mates: EQCD, EQDP

Standoffs:

SO

SPECIFICATIONS

Insulator Material: Liquid Crystal Polymer Contact Material: Phosphor Bronze Plating: Au or Sn over 50 μ" (1.27 μm) Ni Operating Temp Range: -55 °C to +125 °C **Current Rating:** Contact: Contact: 2 A per pin (2 pins powered) Ground Plane: 23 A per ground plane (1 ground plane powered) Voltage Rating: 225 VAC/318 VDC Max Cycles: 100

PROCESSING

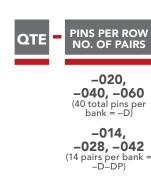
Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (020-060)

Board Stacking:

For applications requiring more than two connectors contact ipg@samtec.com





QTE LEAD STYLE	A	HEIGHT WITH QSE*
-01	(4.27) .168	(5.00) .197
-02	(7.26) .286	(8.00) .315
-03	(10.27) .404	(11.00) .433
-04	(15.25) .600	(16.00) .630
-05	(18.26) .718	(19.00) .748
-07	(24.24) .954	(25.00) .984
-09	(13.26) .522	(14.00) .551

-020,

-014,

-D-DP)

*Processing conditions will affect mated height. See SO Series for board space tolerances.

PINS PER ROW NO. OF PAIRS

-014,

-028, -042

-D-DP = (No. of Positions per Row/14) x —— (20.00) .7875 + (1.27) .050 ——

(3.05)

(14 pairs per bank)= -D-DP

PLATING

OPTION

LEAD

STYLE

Specify LEAD

STYLE

from

Chart

-F = Gold flash on contact, Matte Tin on tail

> : 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail

-C = 50 μ" (1.27 μm) Electro-Polished Selective Gold on contact, Matte Tin on tail (passes 10 year MFG testing)

TYPE OPTIONS

-D Single-Ended

-D-DP = Differential Pair (-01 only)

-K = (7.00 mm).275" DIA Polyimide film Pick & Place Pad

OTHER

-L = Latching Option (N/A on -042 & -060 positions)

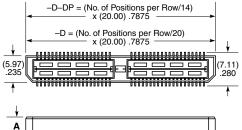
Leave blank for Tray Packaging

"X"R

-TR =Tape & Reel (Not available with -05 & -07 lead style)

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks) (Not available with -05 & -07

lead style)



-D

Single

Ended

-D-DP

= Differential

Pair

.030

View complete specifications at: samtec.com?QTE

01

-020,**-040, -060** (40 total pins per bank = -D)

-F = Gold flash on contact, Matte Tin on tail

PLATING

OPTION

=10 µ" (0.25 µm) Gold on contact, Matte Tin on tail

= 50 μ" (1.27 μm) Electro-Polished Selective Gold on contact, Matte Tin on tail (passes 10 year MFG testing) (7.49)295

(0.76) 0.30

OPTIONS

-GP = Guide Post

-K = (8.25 mm) .325" DIA Polyimide Film Pick &

Place Pad

-L = Latching Option (Not available on -042 & -060 positions)

Leave blank for Tray Packaging

"X"R

-TR =Tape & Reel (40 positions max. with –GP)

-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks) (40 positions max. with –GP)



Note: Some lengths, styles and options are non-standard, non-returnable.

View complete specifications at: samtec.com?QSE

Mouser Electronics

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Samtec:

QTE-060-02-H-D-LC